

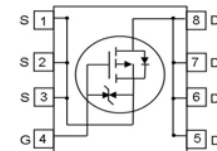
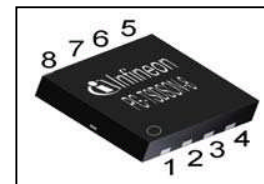
OptiMOS™ P3 Power-Transistor
Features

- single P-Channel in S308
- Qualified according JEDEC¹⁾ for target applications
- 150 °C operating temperature
- $V_{GS}=25$ V, specially suited for notebook applications
- Pb-free; RoHS compliant
- ESD protected
- applications: battery management, load switching
- Halogen-free according to IEC61249-2-21


Product Summary

| | | |
|------------------|-------|------------|
| V_{DS} | -30 | V |
| $R_{DS(on),max}$ | 18 | m Ω |
| I_D | -39.6 | A |

PG-TSDSON-8



| Type | Package | Marking | Lead free | Halogen free | Packing |
|-----------------|-------------|---------|-----------|--------------|---------|
| BSZ180P03NS3E G | PG-TSDSON-8 | 180P3NE | Yes | Yes | non-dry |

Maximum ratings, at $T_j=25$ °C, unless otherwise specified

| Parameter | Symbol | Conditions | Value | Unit |
|-------------------------------------|----------------|-----------------------------------|------------------|------|
| Continuous drain current | I_D | $T_C=25$ °C | 39.6 | A |
| | | $T_C=70$ °C | 32.0 | |
| | | $T_A=25$ °C ²⁾ | -9.0 | |
| Pulsed drain current | $I_{D,pulse}$ | $T_C=25$ °C ³⁾ | -158 | |
| Avalanche energy, single pulse | E_{AS} | $I_D=-20$ A, $R_{GS}=25$ Ω | 48 | mJ |
| Gate source voltage | V_{GS} | | ± 25 | V |
| Power dissipation | P_{tot} | $T_A=25$ °C | 40 | W |
| | | $T_A=25$ °C ²⁾ | 2.1 | |
| Operating and storage temperature | T_j, T_{stg} | | -55 ... 150 | °C |
| ESD class | | JESD22-A114 HBM | class 2 (> 2 kV) | |
| Soldering temperature | | | 260 | °C |
| IEC climatic category; DIN IEC 68-1 | | | 55/150/56 | |

¹⁾ J-STD20 and JESD22

| Parameter | Symbol | Conditions | Values | | | Unit |
|-----------|--------|------------|--------|------|------|------|
| | | | min. | typ. | max. | |

Thermal characteristics

| | | | | | | |
|--|------------|--|---|---|-----|-----|
| Thermal resistance, junction - case | R_{thJC} | | - | - | 3.1 | K/W |
| Thermal resistance, junction - ambient | R_{thJA} | 6 cm ² cooling area ²⁾ | - | - | 60 | |

Electrical characteristics, at $T_j=25$ °C, unless otherwise specified
Static characteristics

| | | | | | | |
|----------------------------------|---------------|--|------|------|------|------------|
| Drain-source breakdown voltage | $V_{(BR)DSS}$ | $V_{GS}=0$ V, $I_D=-250$ μ A | -30 | - | - | V |
| Gate threshold voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}$, $I_D=-48$ μ A | -3.1 | -2.5 | -1.9 | |
| Zero gate voltage drain current | I_{DSS} | $V_{DS}=-30$ V, $V_{GS}=0$ V, $T_j=25$ °C | - | - | -1 | μ A |
| | | $V_{DS}=-30$ V, $V_{GS}=0$ V, $T_j=125$ °C | - | - | -100 | |
| Gate-source leakage current | I_{GSS} | $V_{GS}=-25$ V, $V_{DS}=0$ V | - | - | -10 | μ A |
| Drain-source on-state resistance | $R_{DS(on)}$ | $V_{GS}=-6$ V, $I_D=-13$ A | - | 18.4 | 30.0 | m Ω |
| | | $V_{GS}=-10$ V, $I_D=-20$ A | - | 13.5 | 18.0 | |
| Gate resistance | R_G | | - | 3.1 | - | Ω |
| Transconductance | g_{fs} | $ V_{DS} >2 I_D R_{DS(on)max}$, $I_D=-20$ A | 18 | 29 | - | S |

²⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.

³⁾ See Fig. 3 for more detailed information

| Parameter | Symbol | Conditions | Values | | | Unit |
|-----------|--------|------------|--------|------|------|------|
| | | | min. | typ. | max. | |

Dynamic characteristics

| | | | | | | |
|------------------------------|--------------|--|---|------|------|----|
| Input capacitance | C_{iss} | $V_{GS}=0\text{ V}, V_{DS}=-15\text{ V},$ $f=1\text{ MHz}$ | - | 1480 | 2220 | pF |
| Output capacitance | C_{oss} | | - | 744 | 1116 | |
| Reverse transfer capacitance | C_{rss} | | - | 49 | 73.5 | |
| Turn-on delay time | $t_{d(on)}$ | $V_{DD}=-15\text{ V}, V_{GS}=-10\text{ V}, I_D=-20\text{ A},$ $R_G=6\ \Omega$ | - | 11 | 17 | ns |
| Rise time | t_r | | - | 11 | 16.5 | |
| Turn-off delay time | $t_{d(off)}$ | | - | 20 | 30 | |
| Fall time | t_f | | - | 3 | 5 | |

Gate Charge Characteristics³⁾

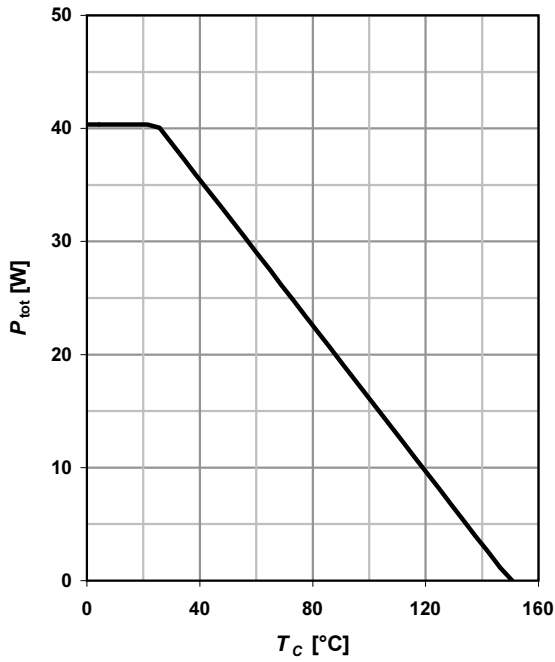
| | | | | | | |
|--------------------------|---------------|--|---|-----|----|----|
| Gate to source charge | Q_{gs} | $V_{DD}=-15\text{ V}, I_D=20\text{ A},$ $V_{GS}=0\text{ to }-10\text{ V}$ | - | 8 | 12 | nC |
| Gate charge at threshold | $Q_{g(th)}$ | | - | 2 | 3 | |
| Gate to drain charge | Q_{gd} | | - | 4 | 5 | |
| Switching charge | Q_{sw} | | - | 9 | 13 | |
| Gate charge total | Q_g | | - | 20 | 30 | |
| Gate plateau voltage | $V_{plateau}$ | | - | 5.0 | - | V |
| Output charge | Q_{oss} | $V_{DD}=-15\text{ V}, V_{GS}=0\text{ V}$ | - | 17 | 26 | nC |

Reverse Diode

| | | | | | | |
|----------------------------------|---------------|--|---|----|------|----|
| Diode continuous forward current | I_S | $T_C=25\text{ }^\circ\text{C}$ | - | - | 40 | A |
| Diode pulse current | $I_{S,pulse}$ | | - | - | 160 | |
| Diode forward voltage | V_{SD} | $V_{GS}=0\text{ V}, I_F=-20\text{ A},$ $T_j=25\text{ }^\circ\text{C}$ | - | - | -1.1 | V |
| Reverse recovery time | t_{rr} | $V_R=15\text{ V}, I_F= I_S ,$ $di_F/dt=100\text{ A}/\mu\text{s}$ | - | 41 | - | ns |
| Reverse recovery charge | Q_{rr} | | - | 41 | - | nC |

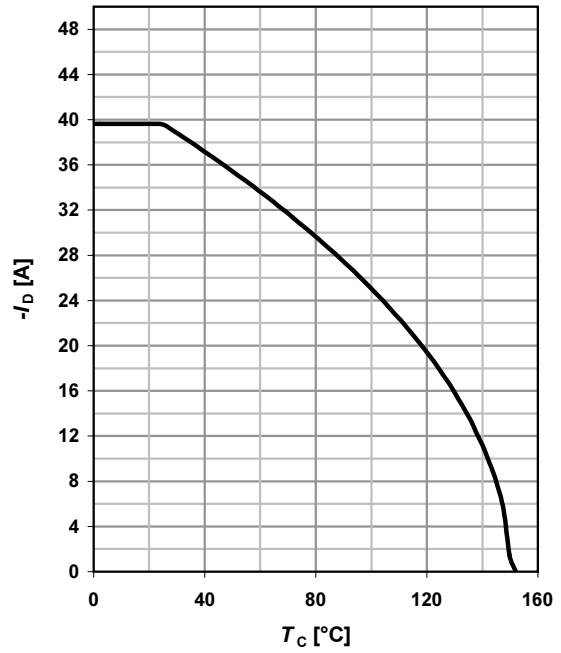
1 Power dissipation

$P_{tot}=f(T_C); t_p \leq 10 \text{ s}$



2 Drain current

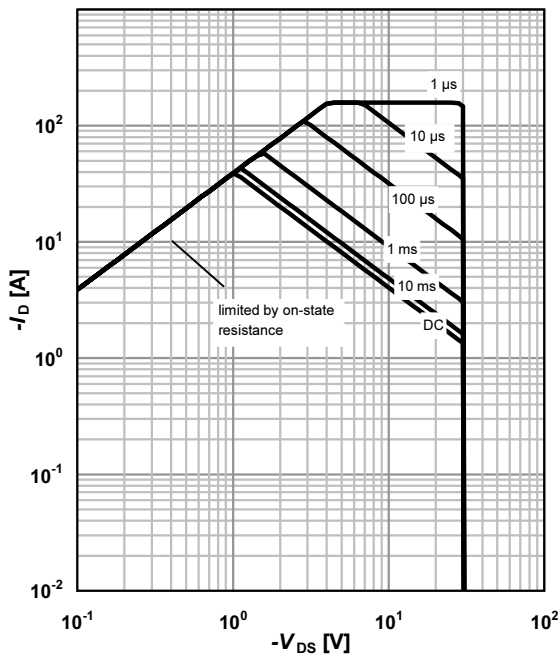
$I_D=f(T_C); |V_{GS}| \geq 10 \text{ V}; t_p \leq 10 \text{ s}$



3 Safe operating area

$I_D=f(V_{DS}); T_C=25 \text{ °C}^1; D=0$

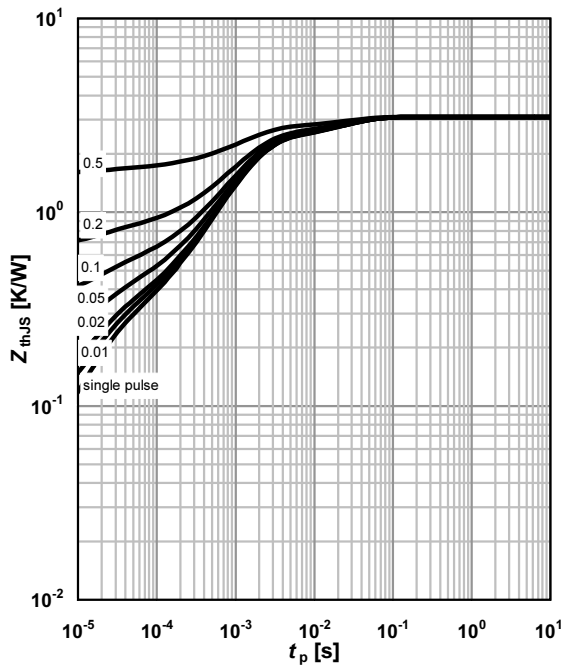
parameter: t_p



4 Max. transient thermal impedance

$Z_{thJS}=f(t_p)$

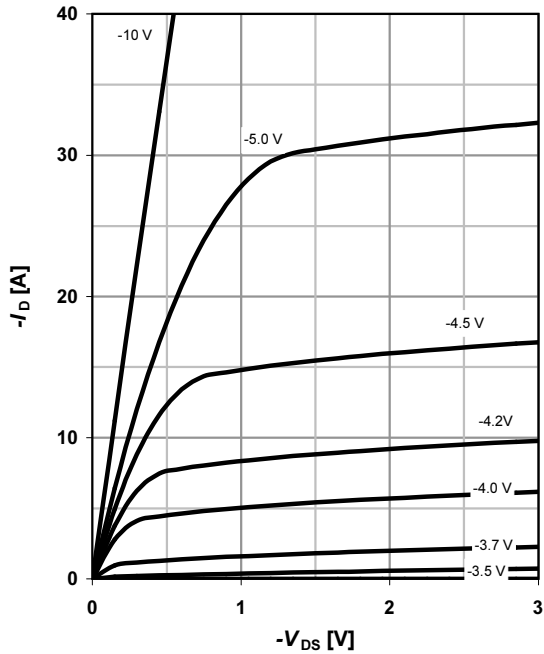
parameter: $D=t_p/T$



5 Typ. output characteristics

$I_D = f(V_{DS}); T_j = 25\text{ °C}$

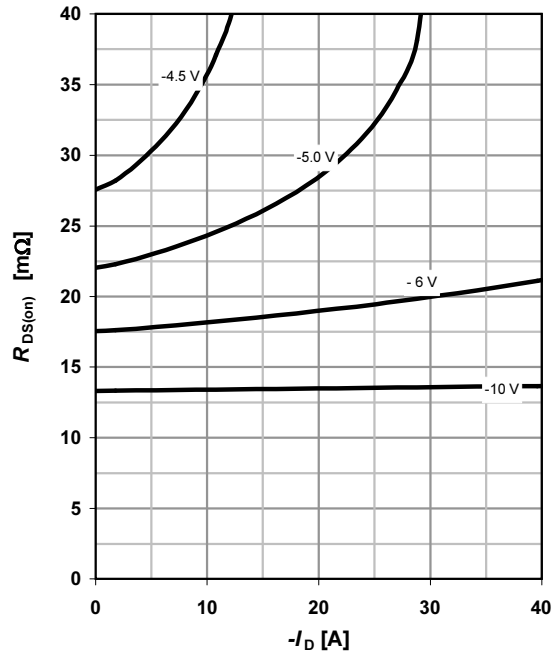
parameter: V_{GS}



6 Typ. drain-source on resistance

$R_{DS(on)} = f(I_D); T_j = 25\text{ °C}$

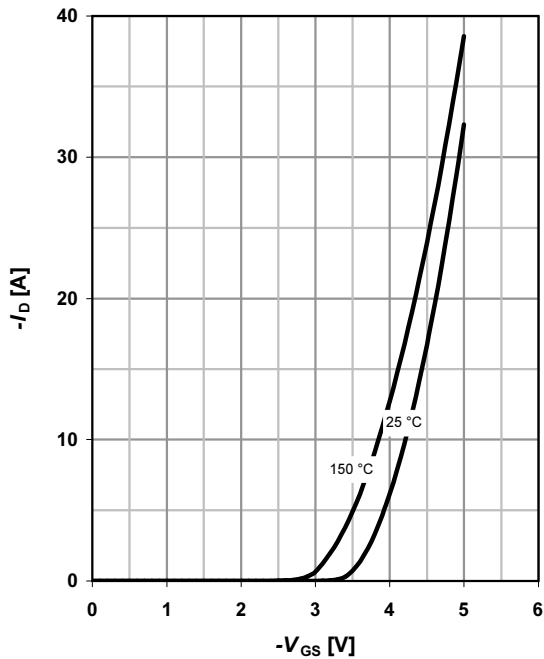
parameter: V_{GS}



7 Typ. transfer characteristics

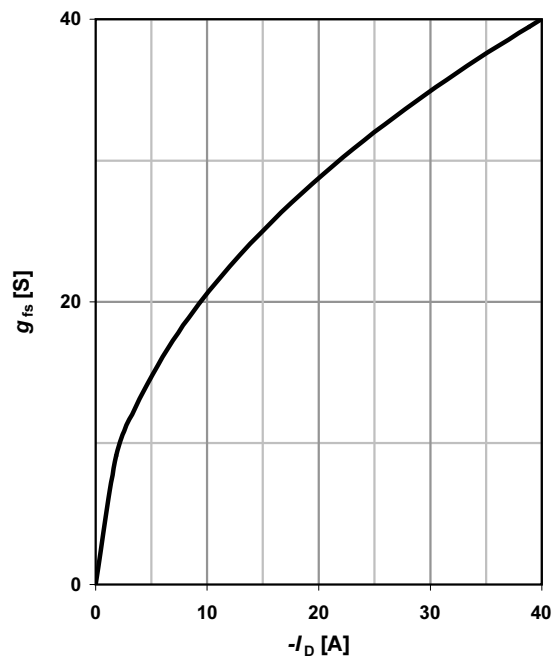
$I_D = f(V_{GS}); |V_{DS}| > 2|I_D|R_{DS(on)max}$

parameter: T_j



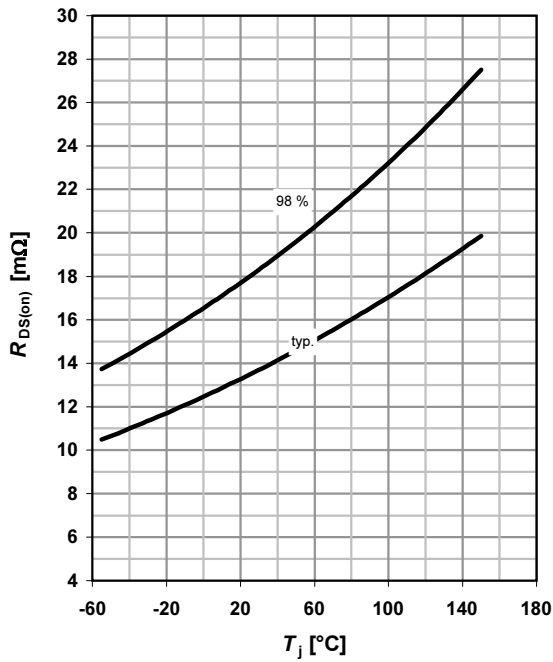
8 Typ. forward transconductance

$g_{fs} = f(I_D); T_j = 25\text{ °C}$

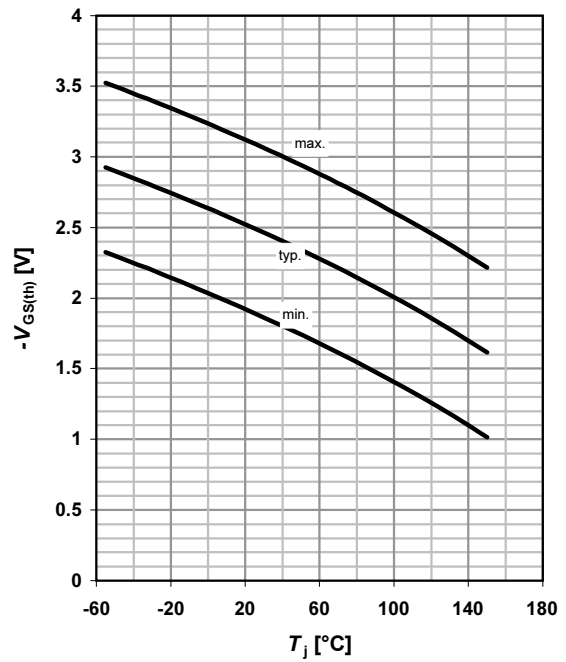


9 Drain-source on-state resistance

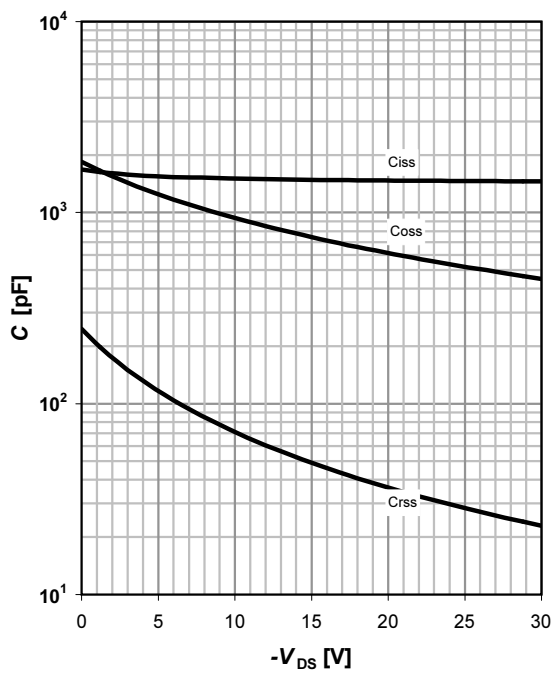
$$R_{DS(on)} = f(T_j); I_D = -20 \text{ A}; V_{GS} = -10 \text{ V}$$


10 Typ. gate threshold voltage

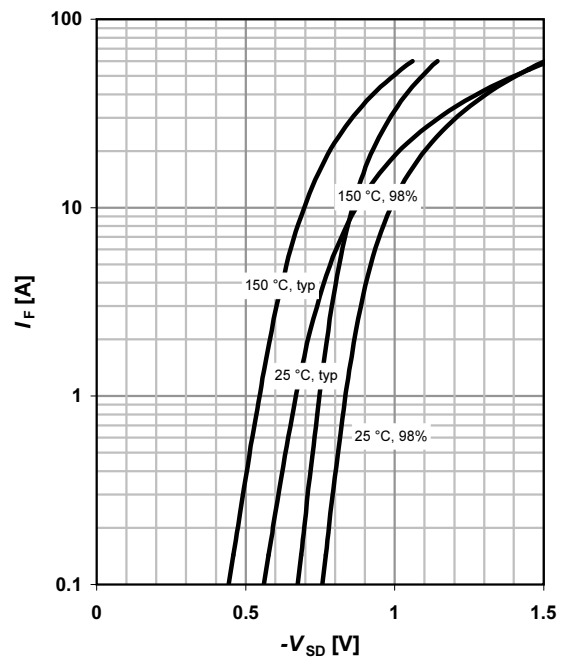
$$V_{GS(th)} = f(T_j); V_{GS} = V_{DS}; I_D = -48 \mu\text{A}$$


11 Typ. capacitances

$$C = f(V_{DS}); V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}$$


12 Forward characteristics of reverse diode

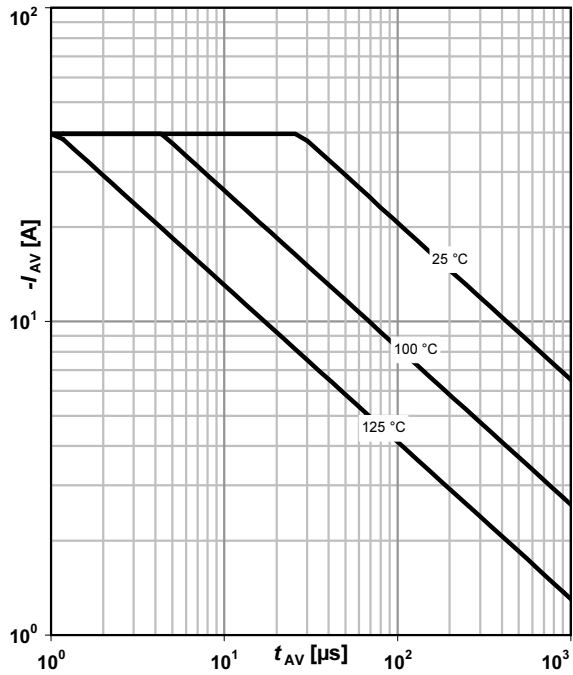
$$I_F = f(V_{SD})$$

 parameter: T_j


13 Avalanche characteristics

$I_{AS}=f(t_{AV}); R_{GS}=25 \Omega$

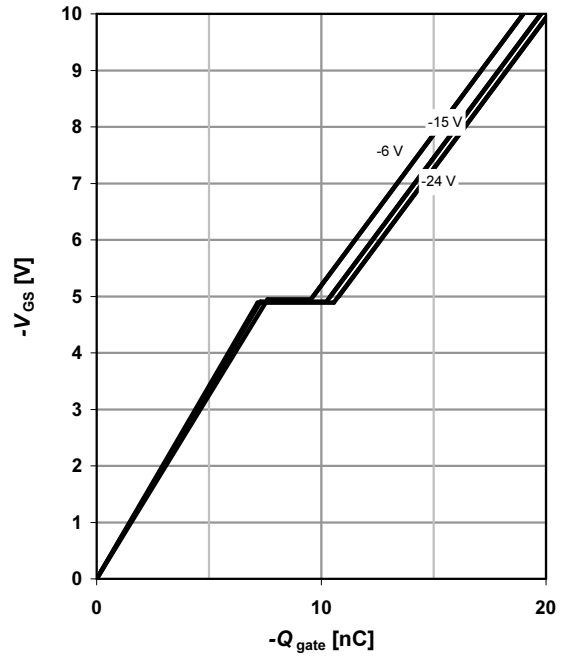
parameter: $T_{j(start)}$



14 Typ. gate charge

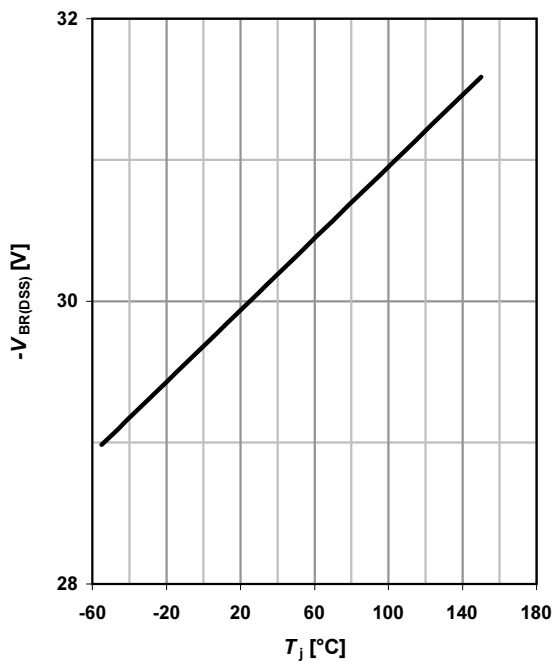
$V_{GS}=f(Q_{gate}); I_D=-20$ A pulsed

parameter: V_{DD}

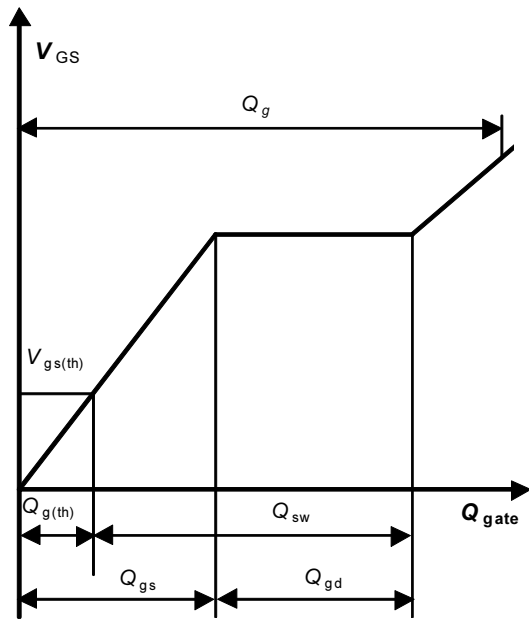


15 Drain-source breakdown voltage

$V_{BR(DSS)}=f(T_j); I_D=-250 \mu$ A

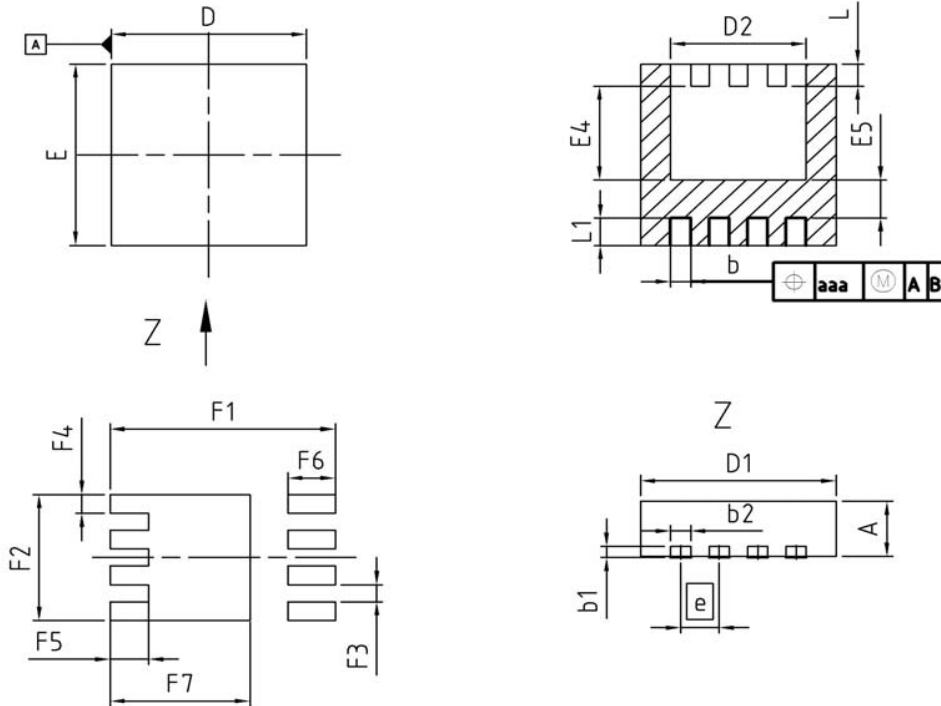


16 Gate charge waveforms



Package Outline

PG-TSDSON-8



| DIM | MILLIMETERS | | INCHES | |
|------|-------------|------|--------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.90 | 1.10 | 0.035 | 0.043 |
| b | 0.24 | 0.44 | 0.009 | 0.017 |
| b1 | 0.10 | 0.30 | 0.004 | 0.012 |
| b2 | 0.20 | 0.44 | 0.008 | 0.017 |
| D=D1 | 3.20 | 3.40 | 0.126 | 0.134 |
| D2 | 2.15 | 2.45 | 0.085 | 0.096 |
| E | 3.20 | 3.40 | 0.126 | 0.134 |
| E4 | 1.60 | 1.81 | 0.063 | 0.071 |
| E5 | 0.59 | 0.86 | 0.023 | 0.034 |
| e | 0.65 | | 0.026 | |
| N | 8 | | 8 | |
| L | 0.30 | 0.56 | 0.012 | 0.022 |
| L1 | 0.33 | 0.60 | 0.013 | 0.024 |
| aaa | 0.25 | | 0.010 | |
| F1 | 3.80 | | 0.150 | |
| F2 | 2.29 | | 0.090 | |
| F3 | 0.31 | | 0.012 | |
| F4 | 0.34 | | 0.013 | |
| F5 | 0.65 | | 0.026 | |
| F6 | 0.80 | | 0.031 | |
| F7 | 2.36 | | 0.093 | |

| |
|-----------------------------|
| DOCUMENT NO. Z8B00131645 |
| SCALE |
| EUROPEAN PROJECTION |
| ISSUE DATE 17-09-2008 |
| REVISION 02 |

Dimensions in mm

Published by
Infineon Technologies AG
81726 Munich, Germany
© 2009 Infineon Technologies AG
All Rights Reserved.

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

Information

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (www.infineon.com).

Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office. The Infineon Technologies component described in this Data Sheet may be used in life-support devices or systems and/or automotive, aviation and aerospace applications or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support, automotive, aviation and aerospace device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [MOSFET](#) category:

Click to view products by [Infineon](#) manufacturer:

Other Similar products are found below :

[614233C](#) [648584F](#) [IRFD120](#) [JANTX2N5237](#) [FCA20N60_F109](#) [FDZ595PZ](#) [2SK2545\(Q,T\)](#) [405094E](#) [423220D](#) [TPCC8103,L1Q\(CM](#)
[MIC4420CM-TR](#) [VN1206L](#) [614234A](#) [715780A](#) [NTNS3166NZT5G](#) [SSM6J414TU,LF\(T](#) [751625C](#) [BUK954R8-60E](#) [GROUP A 5962-](#)
[8877003PA](#) [NTE6400](#) [SQJ402EP-T1-GE3](#) [2SK2614\(TE16L1,Q\)](#) [2N7002KW-FAI](#) [DMN1017UCP3-7](#) [EFC2J004NUZTDG](#) [ECH8691-TL-W](#)
[FCAB21350L1](#) [P85W28HP2F-7071](#) [DMN1053UCP4-7](#) [NTE221](#) [NTE222](#) [NTE2384](#) [NTE2903](#) [NTE2941](#) [NTE2945](#) [NTE2946](#) [NTE2960](#)
[NTE2967](#) [NTE2969](#) [NTE2976](#) [NTE6400A](#) [NTE2910](#) [NTE2916](#) [NTE2956](#) [NTE2911](#) [DMN2080UCB4-7](#) [TK10A80W,S4X\(S](#)
[SSM6P69NU,LF](#) [DMP22D4UFO-7B](#) [DMN1006UCA6-7](#)